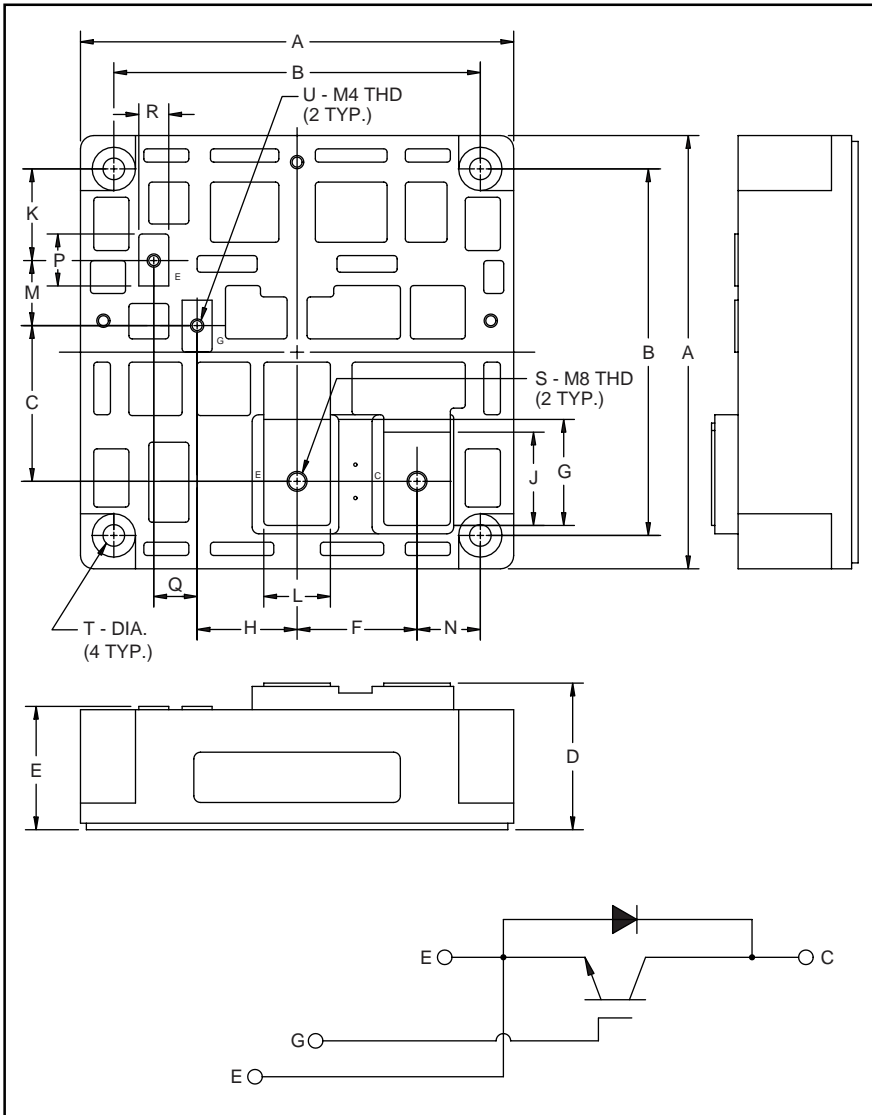


MITSUBISHI IGBT MODULES

CM1000HA-24H

HIGH POWER SWITCHING USE
INSULATED TYPE



Outline Drawing and Circuit Diagram

| Dimensions | Inches | Millimeters |
|------------|-----------------|---------------|
| A | 5.12 | 130.0 |
| B | 4.33±0.01 | 110.0±0.25 |
| C | 1.840 | 46.75 |
| D | 1.73+0.04/-0.02 | 44.0+1.0/-0.5 |
| E | 1.46+0.04/-0.02 | 37.0+1.0/-0.5 |
| F | 1.42 | 36.0 |
| G | 1.25 | 31.8 |
| H | 1.18 | 30.0 |
| J | 1.10 | 28.0 |
| K | 1.08 | 27.5 |

| Dimensions | Inches | Millimeters |
|------------|-----------|-------------|
| L | 0.79 | 20.0 |
| M | 0.77 | 19.5 |
| N | 0.75 | 19.0 |
| P | 0.61 | 15.6 |
| Q | 0.51 | 13.0 |
| R | 0.35 | 9.0 |
| S | M8 Metric | M8 |
| T | 0.26 Dia. | Dia. 6.5 |
| U | M4 Metric | M4 |



Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of one IGBT in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM1000HA-24H is a 1200V (V_{CES}), 1000 Ampere Single IGBT Module.

| Type | Current Rating Amperes | V_{CES} Volts (x 50) |
|------|---------------------------|---------------------------|
| CM | 1000 | 24 |

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Absolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Ratings | Symbol | CM1000HA-24H | Units |
|--|------------------|--------------|------------------|
| Junction Temperature | T_j | -40 to +150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -40 to +125 | $^\circ\text{C}$ |
| Collector-Emitter Voltage (G-E SHORT) | V_{CES} | 1200 | Volts |
| Gate-Emitter Voltage (C-E SHORT) | V_{GES} | ± 20 | Volts |
| Collector Current ($T_C = 25\text{ }^\circ\text{C}$) | I_C | 1000 | Amperes |
| Peak Collector Current ($T_j \leq 150\text{ }^\circ\text{C}$) | I_{CM} | 2000* | Amperes |
| Emitter Current** ($T_C = 25\text{ }^\circ\text{C}$) | I_E | 1000 | Amperes |
| Peak Emitter Current** | I_{EM} | 2000* | Amperes |
| Maximum Collector Dissipation ($T_C = 25\text{ }^\circ\text{C}$) | P_C | 5800 | Watts |
| Mounting Torque, M8 Main Terminal | - | 8.83 ~ 10.8 | N · m |
| Mounting, Torque M6 Mounting | - | 1.96 ~ 2.94 | N · m |
| Mounting, Torque M4 Terminal | - | 0.98 ~ 1.47 | N · m |
| Weight | - | 1600 | Grams |
| Isolation Voltage (Main Terminal to Baseplate, AC 1 min.) | V_{iso} | 2500 | V _{rma} |

 *Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|----------------------|---|------|------|-------|---------------|
| Collector-Cutoff Current | I_{CES} | $V_{\text{CE}} = V_{\text{CES}}, V_{\text{GE}} = 0\text{V}$ | - | - | 6 | mA |
| Gate Leakage Current | I_{GES} | $V_{\text{GE}} = V_{\text{GES}}, V_{\text{CE}} = 0\text{V}$ | - | - | 0.5 | μA |
| Gate-Emitter Threshold Voltage | $V_{\text{GE(th)}}$ | $I_C = 100\text{mA}, V_{\text{CE}} = 10\text{V}$ | 4.5 | 6.0 | 7.5 | Volts |
| Collector-Emitter Saturation Voltage | $V_{\text{CE(sat)}}$ | $I_C = 1000\text{A}, V_{\text{GE}} = 15\text{V}$ | - | 2.7 | 3.6** | Volts |
| | | $I_C = 1000\text{A}, V_{\text{GE}} = 15\text{V}, T_j = 150\text{ }^\circ\text{C}$ | - | 2.4 | - | Volts |
| Total Gate Charge | Q_G | $V_{\text{CC}} = 600\text{V}, I_C = 1000\text{A}, V_{\text{GE}} = 15\text{V}$ | - | 5000 | - | nC |
| Emitter-Collector Voltage | V_{EC} | $I_E = 1000\text{A}, V_{\text{GE}} = 0\text{V}$ | - | - | 3.5 | Volts |

** Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|-------------------------------|---------------------|---|------|------|------|---------------|
| Input Capacitance | C_{ies} | | - | - | 200 | nF |
| Output Capacitance | C_{oes} | $V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}$ | - | - | 70 | nF |
| Reverse Transfer Capacitance | C_{res} | | - | - | 40 | nF |
| Resistive | Turn-on Delay Time | $V_{\text{CC}} = 600\text{V}, I_C = 1000\text{A},$ | - | - | 600 | ns |
| | Load | | | | | |
| Switching | Turn-off Delay Time | $V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}, R_G = 3.3\Omega$ | - | - | 1200 | ns |
| | Time | | | | | |
| Diode Reverse Recovery Time | t_{rr} | $I_E = 1000\text{A}, di_E/dt = -2000\text{A}/\mu\text{s}$ | - | - | 250 | ns |
| Diode Reverse Recovery Charge | Q_{rr} | $I_E = 1000\text{A}, di_E/dt = -2000\text{A}/\mu\text{s}$ | - | 7.4 | - | μC |

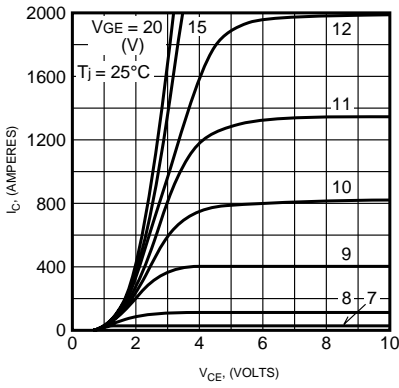
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|----------------------|------------------------------------|------|------|-------|---------------------------|
| Thermal Resistance, Junction to Case | $R_{\text{th(j-c)}}$ | Per IGBT | - | - | 0.022 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction to Case | $R_{\text{th(j-c)}}$ | Per FWDi | - | - | 0.050 | $^\circ\text{C}/\text{W}$ |
| Contact Thermal Resistance | $R_{\text{th(c-f)}}$ | Per Module, Thermal Grease Applied | - | - | 0.018 | $^\circ\text{C}/\text{W}$ |

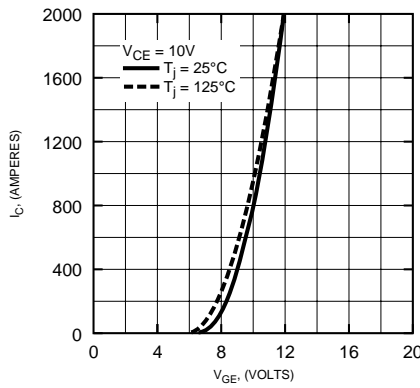
CM1000HA-24H

HIGH POWER SWITCHING USE
INSULATED TYPE

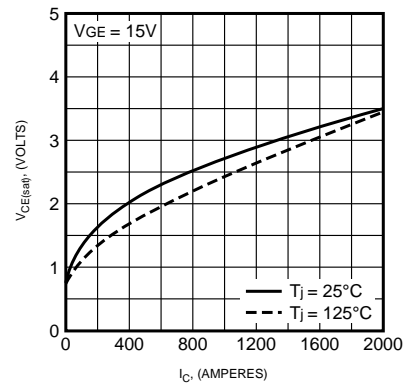
OUTPUT CHARACTERISTICS (TYPICAL)



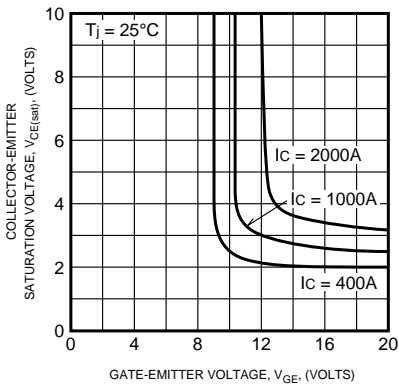
OUTPUT CHARACTERISTICS (TYPICAL)



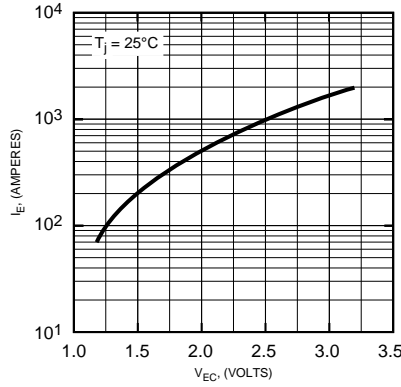
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



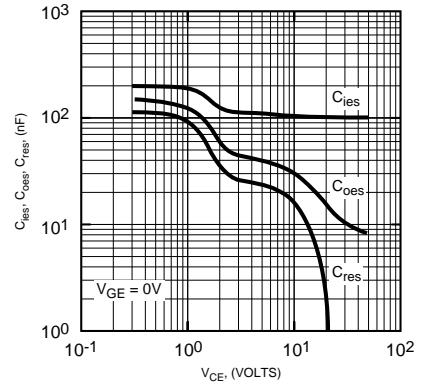
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



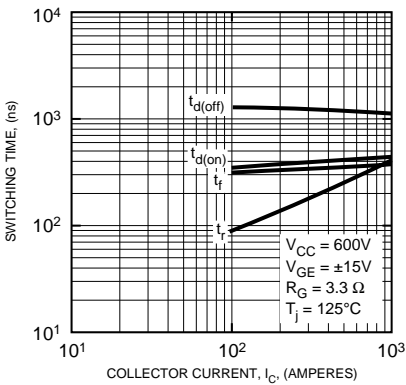
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



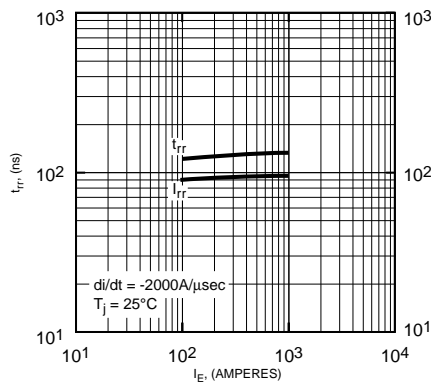
CAPACITANCE VS. V_CE (TYPICAL)



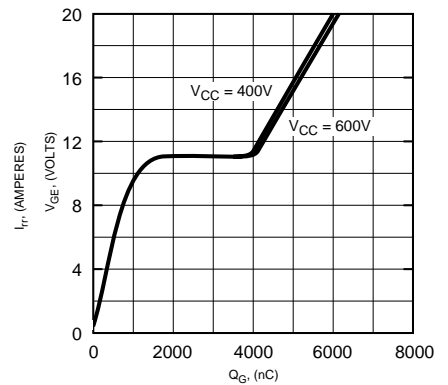
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS (TYPICAL)

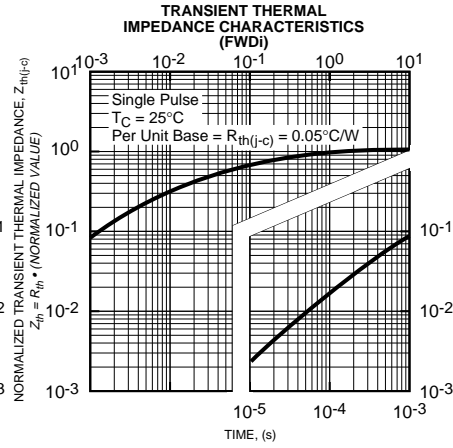
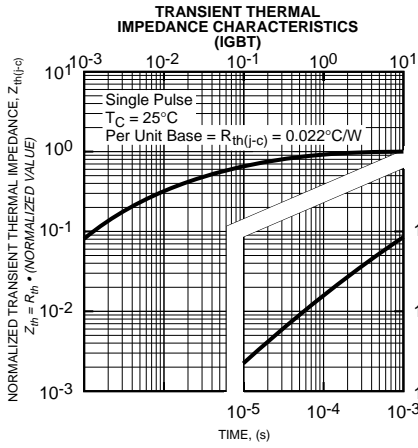


GATE CHARGE, V_GE (TYPICAL)



CM1000HA-24H

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